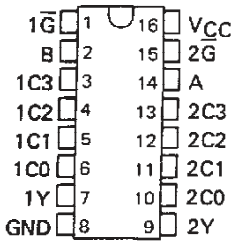
# SN54153, SN54LS153, SN54S153
# SN74153, SN74LS153, SN74S153
# DUAL 4-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

SDLS055A – DECEMBER 1972 – REVISED MAY 2007

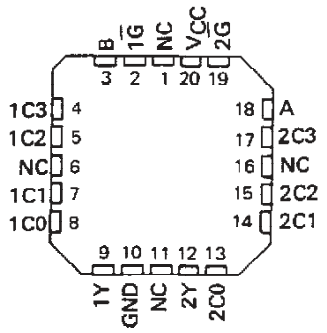
- Permits Multiplexing from N lines to 1 line
- Performs Parallel-to-Serial Conversion
- Strobe (Enable) Line Provided for Cascading (N lines to n lines)
- High-Fan-Out, Low-Impedance, Totem-Pole Outputs
- Fully Compatible with most TTL Circuits

| TYPE | TYPICAL AVERAGE PROPAGATION DELAY TIMES | | | TYPICAL POWER DISSIPATION |
|---|---|---|---|---|
| | FROM DATA | FROM STROBE | FROM SELECT | |
| '153 | 14 ns | 17 ns | 22 ns | 180 mW |
| 'LS153 | 14 ns | 19 ns | 22 ns | 31 mW |
| 'S153 | 6 ns | 9.5 ns | 12 ns | 225 mW |

SN54153, SN54LS153, SN54S153 . . . J OR W PACKAGE(1)
SN74153 . . . N PACKAGE
SN74LS153, SN74S153 . . . D OR N PACKAGE
(TOP VIEW)




SN54LS153, SN54S153 . . . FK PACKAGE (1)
(TOP VIEW)




NC – No internal connection

(1) SN54S153, SN74153, and SN74S153 are obsolete.

## description

Each of these monolithic, data selectors/multiplexers contains inverters and drivers to supply fully complementary, on-chip, binary decoding data selection to the AND-OR gates. Separate strobe inputs are provided for each of the two four-line sections.

FUNCTION TABLE

| SELECT INPUTS | | DATA INPUTS | | | | STROBE | OUTPUT |
|---|---|---|---|---|---|---|---|
| B | A | C0 | C1 | C2 | C3 | $\overline{G}$ | Y |
| X | X | X | X | X | X | H | L |
| L | L | L | X | X | X | L | L |
| L | L | H | X | X | X | L | H |
| L | H | X | L | X | X | L | L |
| L | H | X | H | X | X | L | H |
| H | L | X | X | L | X | L | L |
| H | L | X | X | H | X | L | H |
| H | H | X | X | X | L | L | L |
| H | H | X | X | X | H | L | H |

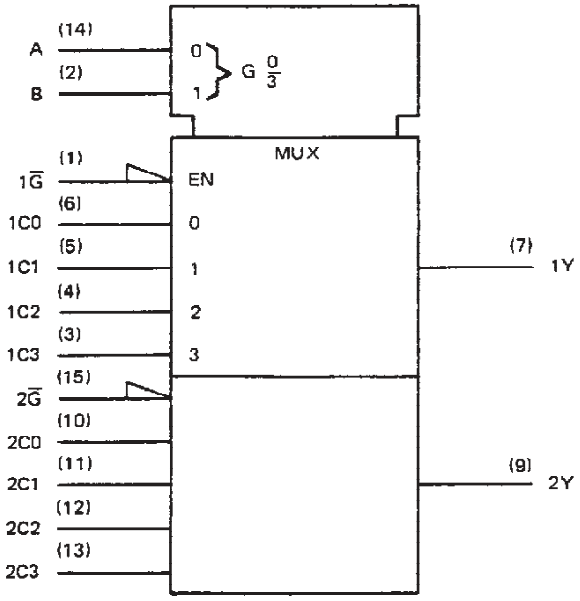
Select inputs A and B are common to both sections.
H = high level, L = low level, X = irrelevant

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, $V_{CC}$ (See Note 1) . . . . . 7 V
Input voltage: '153, 'S153 . . . . . 5.5 V
'LS153 . . . . . 7 V
Operating free-air temperature range: SN54' . . . . . −55°C to 125°C
SN74' . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

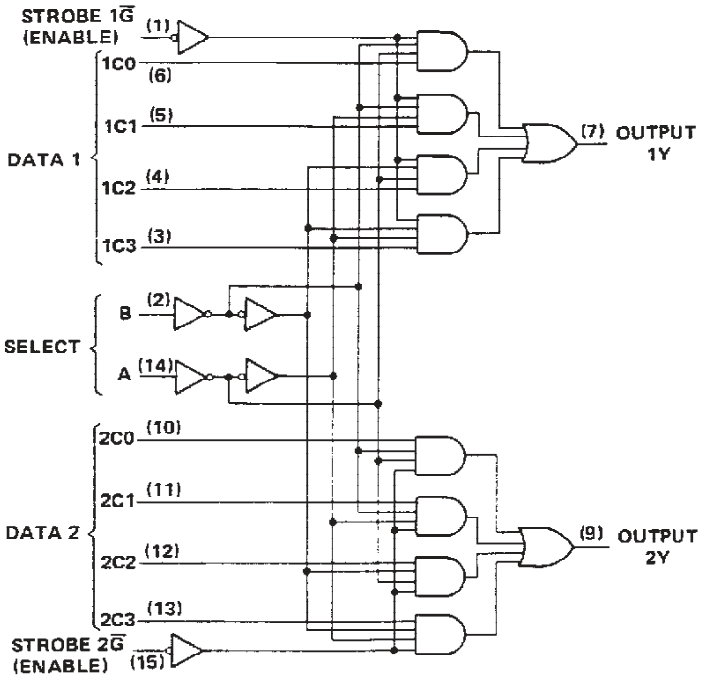
NOTE 1: Voltage values are with respect to network ground terminal.

## logic symbol†




†This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

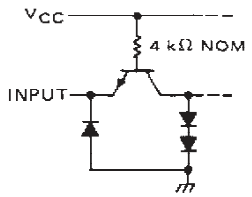
## logic diagrams (positive logic)



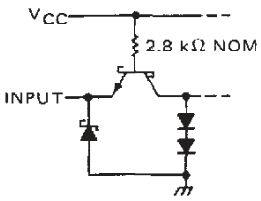

Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs

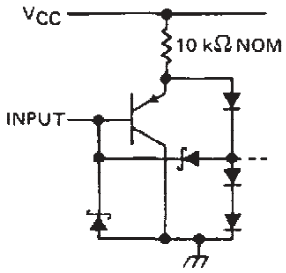
EQUIVALENT OF INPUTS OF '153



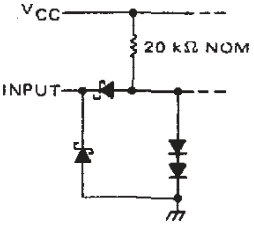

EQUIVALENT OF INPUTS OF 'S153



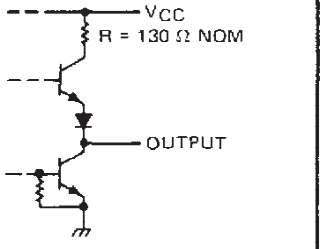

EQUIVALENT OF $1\overline{G}$, $2\overline{G}$ INPUTS OF LS153



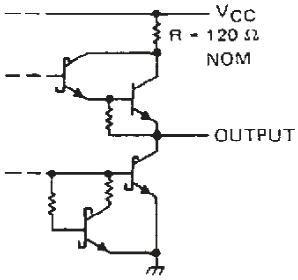

EQUIVALENT OF ALL OTHER INPUTS OF 'LS153



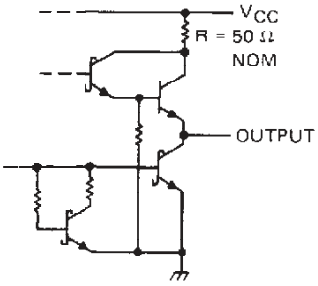

TYPICAL OF OUTPUTS OF '153




TYPICAL OF OUTPUTS OF 'LS153




TYPICAL OF OUTPUTS OF 'S153



## recommended operating conditions

| | SN54153 | | | SN74153 | | | UNIT |
|---|---|---|---|---|---|---|---|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| Supply voltage, $V_{CC}$ | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| High-level output current, $I_{OH}$ | | | −800 | | | −800 | μA |
| Low-level output current, $I_{OL}$ | | | 16 | | | 16 | mA |
| Operating free-air temperature, $T_A$ | −55 | | 125 | 0 | | 70 | °C |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS† | SN54153 | | | SN74153 | | | UNIT |
|---|---|---|---|---|---|---|---|---|---|
| | | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| $V_{IH}$ | High-level input voltage | | 2 | | | 2 | | | V |
| $V_{IL}$ | Low-level input voltage | | | | 0.8 | | | 0.8 | V |
| $V_{IK}$ | Input clamp voltage | $V_{CC}$ = MIN, $I_I$ = −12 mA | | | −1.5 | | | −1.5 | V |
| $V_{OH}$ | High-level output voltage | $V_{CC}$ = MIN, $V_{IH}$ = 2 V, $V_{IL}$ = 0.8 V, $I_{OH}$ = −800 μA | 2.4 | 3.4 | | 2.4 | 3.4 | | V |
| $V_{OL}$ | Low-level output voltage | $V_{CC}$ = MIN, $V_{IH}$ = 2 V, $V_{IL}$ = 0.8 V, $I_{OL}$ = 16 mA | | 0.2 | 0.4 | | 0.2 | 0.4 | V |
| $I_I$ | Input current at maximum input voltage | $V_{CC}$ = MAX, $V_I$ = 5.5 V | | | 1 | | | 1 | mA |
| $I_{IH}$ | High-level input current | $V_{CC}$ = MAX, $V_I$ = 2.4 V | | | 40 | | | 40 | μA |
| $I_{IL}$ | Low-level input current | $V_{CC}$ = MAX, $V_I$ = 0.4 V | | | −1.6 | | | −1.6 | mA |
| $I_{OS}$ | Short-circuit output current§ | $V_{CC}$ = MAX | −20 | | −55 | −18 | | −57 | mA |
| $I_{CCL}$ | Supply current, output low | $V_{CC}$ = MAX, See Note 2 | | 36 | 52 | | 36 | 60 | mA |

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at $V_{CC}$ = 5 V, $T_A$ = 25°C.
§Not more than one output should be shorted at a time.
NOTE 2: $I_{CCL}$ is measured with the outputs open and all inputs grounded.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

| PARAMETER¶ | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|---|---|---|---|---|---|
| $t_{PLH}$ | Data | Y | $C_L$ = 30 pF, $R_L$ = 400 Ω, See Note 3 | | 12 | 18 | ns |
| $t_{PHL}$ | Data | Y | | | 15 | 23 | ns |
| $t_{PLH}$ | Select | Y | | | 22 | 34 | ns |
| $t_{PHL}$ | Select | Y | | | 22 | 34 | ns |
| $t_{PLH}$ | Strobe $\overline{G}$ | Y | | | 19 | 30 | ns |
| $t_{PHL}$ | Strobe $\overline{G}$ | Y | | | 15 | 23 | ns |

¶$t_{PLH}$ = propagation delay time, low-to-high-level output
$t_{PHL}$ = propagation delay time, high-to-low-level output
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

## recommended operating conditions

| | | SN54LS153 | | | SN74LS153 | | | UNIT |
|---|---|---|---|---|---|---|---|---|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| $V_{CC}$ | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| $V_{IH}$ | High-level input voltage | 2 | | | 2 | | | V |
| $V_{IL}$ | Low-level input voltage | | | 0.7 | | | 0.8 | V |
| $I_{OH}$ | High-level output current | | | −0.4 | | | −0.4 | mA |
| $I_{OL}$ | Low-level output current | | | 4 | | | 8 | mA |
| $T_A$ | Operating free-air temperature | −55 | | 125 | 0 | | 70 | °C |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS† | | SN54LS153 | | | SN74LS153 | | | UNIT |
|---|---|---|---|---|---|---|---|---|---|
| | | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| $V_{IK}$ | $V_{CC}$ = MIN, $I_I$ = −18 mA | | | | −1.5 | | | −1.5 | V |
| $V_{OH}$ | $V_{CC}$ = MIN, $V_{IH}$ = 2 V, $V_{IL}$ = MAX, $I_{OH}$ = −0.4 mA | | 2.5 | 3.4 | | 2.7 | 3.4 | | V |
| $V_{OL}$ | $V_{CC}$ = MIN, $V_{IH}$ = 2 V, $V_{IL}$ = MAX, | $I_{OL}$ = 4 mA | | 0.25 | 0.4 | | 0.25 | 0.4 | V |
| | | $I_{OL}$ = 8 mA | | | | | 0.35 | 0.5 | |
| $I_I$ | $V_{CC}$ = MAX, $V_I$ = 7 V | | | | 0.1 | | | 0.1 | mA |
| $I_{IH}$ | $V_{CC}$ = MAX, $V_I$ = 2.7 V | | | | 20 | | | 20 | μA |
| $I_{IL}$ $\overline{1G}$, 2G | $V_{CC}$ = MAX, $V_I$ = 0.4 V | | | | −0.2 | | | −0.2 | mA |
| $I_{IL}$ All other | | | | | −0.4 | | | −0.4 | |
| $I_{OS}$§ | $V_{CC}$ = MAX | | −20 | | −100 | −20 | | −100 | mA |
| $I_{CCL}$ | $V_{CC}$ = MAX, See Note 2 | | | 6.2 | 10 | | 6.2 | 10 | mA |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at $V_{CC}$ = 5 V, $T_A$ = 25°C.
§ Not more than one output should be shorted at a time.
NOTE 2: $I_{CCL}$ is measured with the outputs open and all inputs grounded.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

| PARAMETER¶ | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|---|---|---|---|---|---|
| $t_{PLH}$ | Data | Y | $C_L$ = 15 pF, $R_L$ = 2 kΩ, See Note 3 | | 10 | 15 | ns |
| $t_{PHL}$ | Data | Y | | | 17 | 26 | ns |
| $t_{PLH}$ | Select | Y | | | 19 | 29 | ns |
| $t_{PHL}$ | Select | Y | | | 25 | 38 | ns |
| $t_{PLH}$ | Strobe $\overline{G}$ | Y | | | 16 | 24 | ns |
| $t_{PHL}$ | Strobe $\overline{G}$ | Y | | | 21 | 32 | ns |

¶ $t_{PLH}$ = propagation delay time, low-to-high-level output
$t_{PHL}$ = propagation delay time, high-to-low-level output
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

## recommended operating conditions

| | SN54S153 | | | SN74S153 | | | UNIT |
|---|---|---|---|---|---|---|---|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| Supply voltage, $V_{CC}$ | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| High-level output current, $I_{OH}$ | | | −1 | | | −1 | mA |
| Low-level output current, $I_{OL}$ | | | 20 | | | 20 | mA |
| Operating free-air temperature, $T_A$ | −55 | | 125 | 0 | | 70 | °C |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS† | | MIN | TYP‡ | MAX | UNIT |
|---|---|---|---|---|---|---|---|
| $V_{IH}$ | High-level input voltage | | | 2 | | | V |
| $V_{IL}$ | Low-level input voltage | | | | | 0.8 | V |
| $V_{IK}$ | Input clamp voltage | $V_{CC}$ = MIN, $I_I$ = −18 mA | | | | −1.2 | V |
| $V_{OH}$ | High-level output voltage | $V_{CC}$ = MIN, $V_{IH}$ = 2 V, $V_{IL}$ = 0.8 V, $I_{OH}$ = −1 mA | Series 54S | 2.5 | 3.4 | | V |
| | | | Series 74S | 2.7 | 3.4 | | |
| $V_{OL}$ | Low-level output voltage | $V_{CC}$ = MIN, $V_{IH}$ = 2 V, $V_{IL}$ = 0.8 V, $I_{OL}$ = 20 mA | | | | 0.5 | V |
| $I_I$ | Input current at maximum input voltage | $V_{CC}$ = MAX, $V_I$ = 5.5 V | | | | 1 | mA |
| $I_{IH}$ | High-level input current | $V_{CC}$ = MAX, $V_I$ = 2.7 V | | | | 50 | μA |
| $I_{IL}$ | Low-level input current | $V_{CC}$ = MAX, $V_I$ = 0.5 V | | | | −2 | mA |
| $I_{OS}$ | Short-circuit output current§ | $V_{CC}$ = MAX | | −40 | | −100 | mA |
| $I_{CCL}$ | Supply current, low-level output | $V_{CC}$ = MAX, See Note 2 | | | 45 | 70 | mA |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at $V_{CC}$ = 5 V, $T_A$ = 25°C.
§ Not more than one output should be shorted at a time and duration of short-circuit should not exceed one second.
NOTE 2: $I_{CCL}$ is measured with the outputs open and all inputs grounded.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

| PARAMETER¶ | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|---|---|---|---|---|---|
| $t_{PLH}$ | Data | Y | $C_L$ = 15 pF, $R_L$ = 280 Ω, See Note 3 | | 6 | 9 | ns |
| $t_{PHL}$ | Data | Y | | | 6 | 9 | ns |
| $t_{PLH}$ | Select | Y | | | 11.5 | 18 | ns |
| $t_{PHL}$ | Select | Y | | | 12 | 18 | ns |
| $t_{PLH}$ | Strobe $\overline{G}$ | Y | | | 10 | 15 | ns |
| $t_{PHL}$ | Strobe $\overline{G}$ | Y | | | 9 | 13.5 | ns |

¶ $t_{PLH}$ = propagation delay time, low-to-high-level output
$t_{PHL}$ = propagation delay time, high-to-low-level output
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

## PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|---|---|---|---|---|---|---|---|---|---|---|---|
| 76011012A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 76011012A SNJ54LS 153FK | Samples |
| 7601101EA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7601101EA SNJ54LS153J | Samples |
| 7601101FA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7601101FA SNJ54LS153W | Samples |
| JM38510/30902BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30902BEA | Samples |
| M38510/30902BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30902BEA | Samples |
| SN54153J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54153J | Samples |
| SN54LS153J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54LS153J | Samples |
| SN74LS153D | ACTIVE | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS153 | Samples |
| SN74LS153DG4 | ACTIVE | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS153 | Samples |
| SN74LS153DR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS153 | Samples |
| SN74LS153N | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS153N | Samples |
| SN74LS153NSR | ACTIVE | SO | NS | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74LS153 | Samples |
| SNJ54153J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54153J | Samples |
| SNJ54LS153FK | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 76011012A SNJ54LS 153FK | Samples |
| SNJ54LS153J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7601101EA SNJ54LS153J | Samples |
| SNJ54LS153W | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7601101FA SNJ54LS153W | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.
**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.
**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



**OTHER QUALIFIED VERSIONS OF SN54LS153, SN74LS153 :**

- Catalog : SN74LS153
- Military : SN54LS153

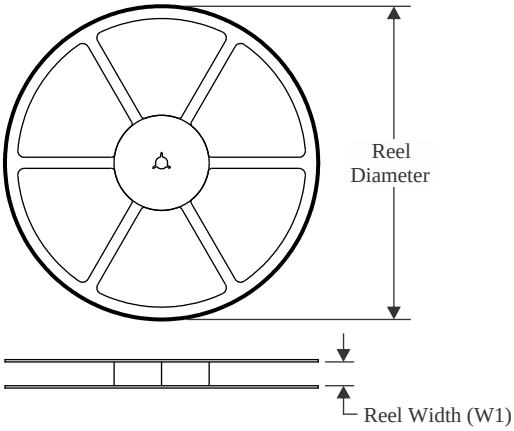
NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

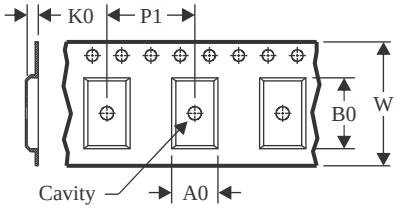
- Military - QML certified for Military and Defense Applications

## TAPE AND REEL INFORMATION

**REEL DIMENSIONS**

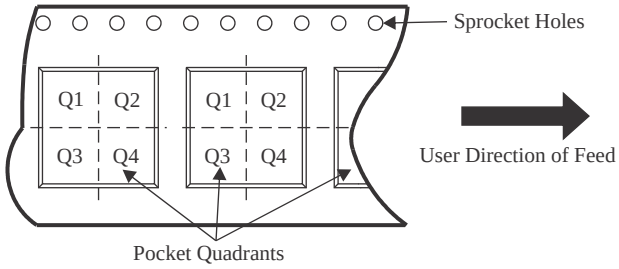



**TAPE DIMENSIONS**




| | |
|---|---|
| A0 | Dimension designed to accommodate the component width |
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

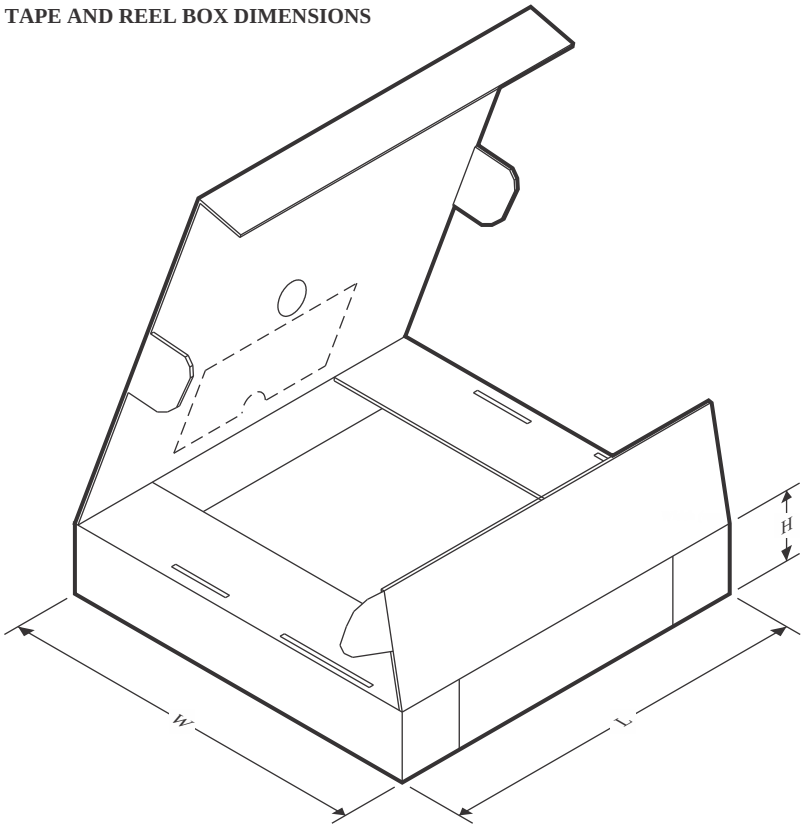
**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**




*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---|---|---|---|---|---|---|---|---|---|---|---|---|
| SN74LS153DR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74LS153NSR | SO | NS | 16 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |

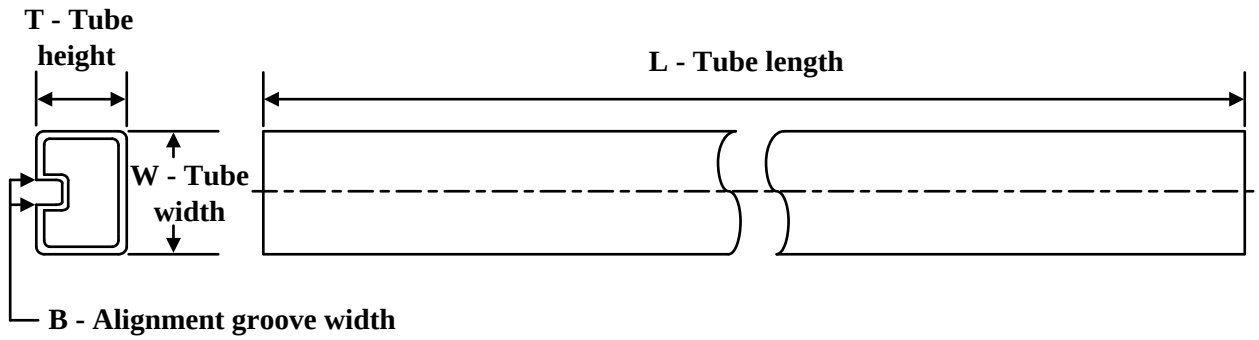
TAPE AND REEL BOX DIMENSIONS




*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---|---|---|---|---|---|---|---|
| SN74LS153DR | SOIC | D | 16 | 2500 | 340.5 | 336.1 | 32.0 |
| SN74LS153NSR | SO | NS | 16 | 2000 | 356.0 | 356.0 | 35.0 |

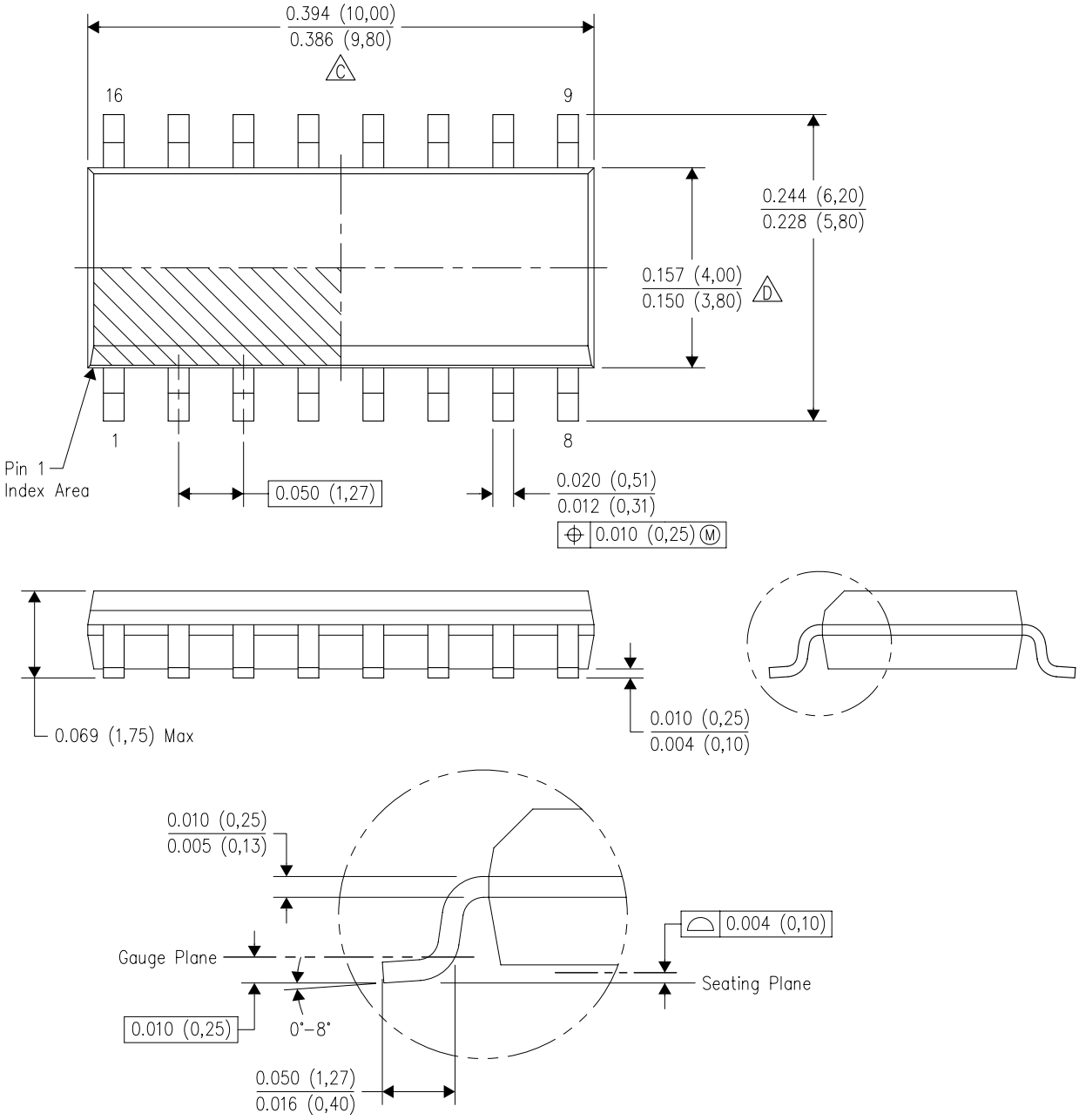
## TUBE




*All dimensions are nominal

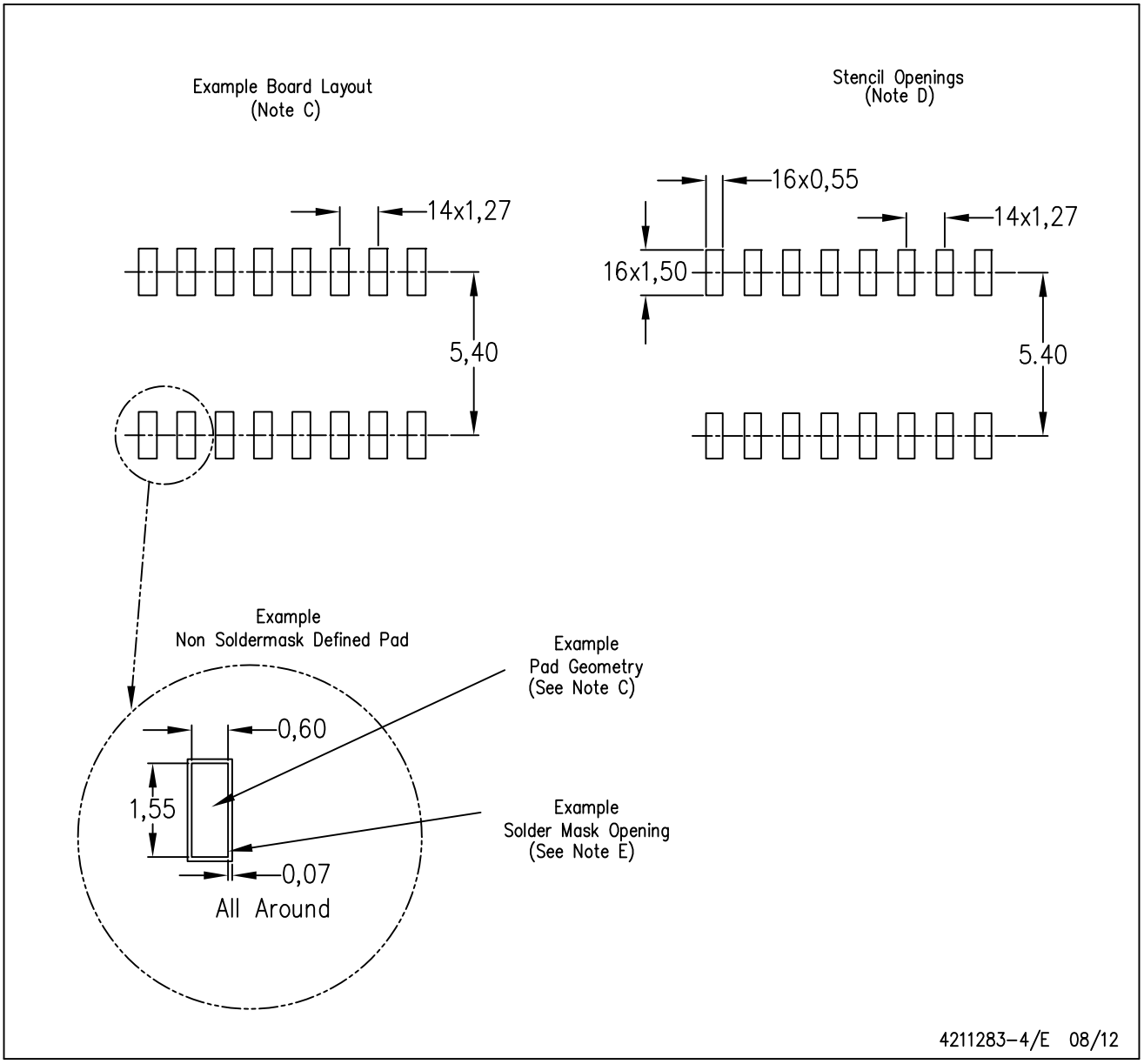
| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|---|---|---|---|---|---|---|---|---|
| 76011012A | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| 7601101FA | W | CFP | 16 | 1 | 506.98 | 26.16 | 6220 | NA |
| SN74LS153D | D | SOIC | 16 | 40 | 507 | 8 | 3940 | 4.32 |
| SN74LS153DG4 | D | SOIC | 16 | 40 | 507 | 8 | 3940 | 4.32 |
| SN74LS153N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74LS153N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SNJ54LS153FK | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| SNJ54LS153W | W | CFP | 16 | 1 | 506.98 | 26.16 | 6220 | NA |

D (R–PDSO–G16) PLASTIC SMALL OUTLINE




NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
E. Reference JEDEC MS–012 variation AC.

D (R–PDSO–G16) PLASTIC SMALL OUTLINE

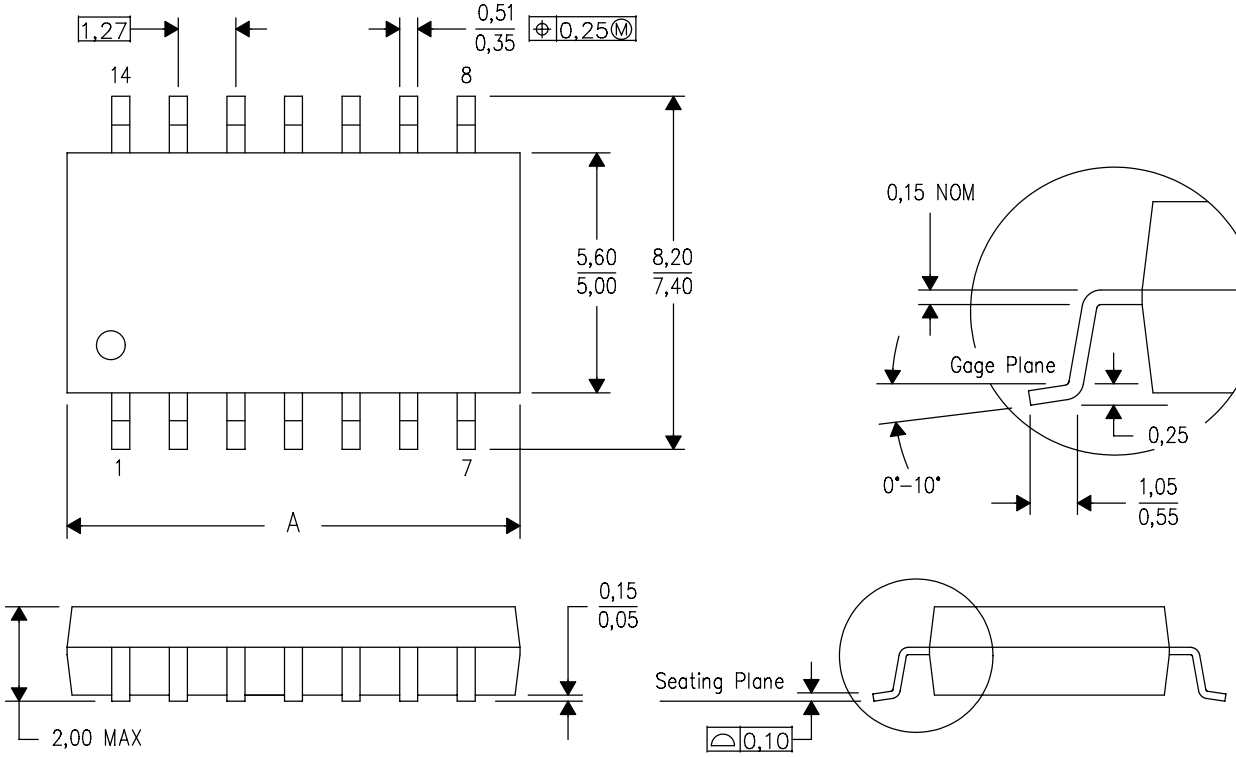



NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC–7351 is recommended for alternate designs.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC–7525 for other stencil recommendations.
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

## MECHANICAL DATA

**NS (R-PDSO-G**)** **PLASTIC SMALL-OUTLINE PACKAGE**

**14-PINS SHOWN**

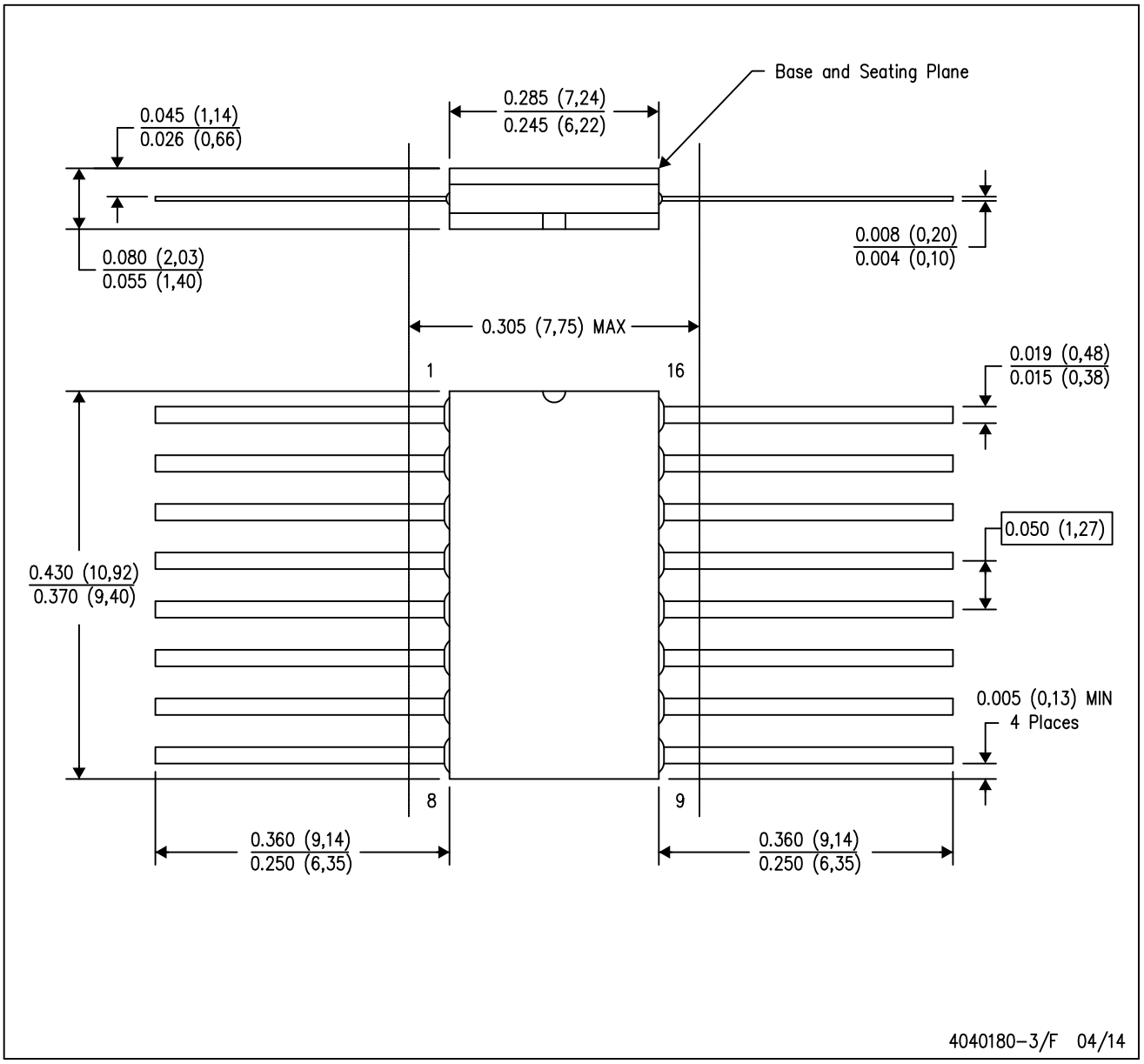



| DIM \ PINS ** | 14 | 16 | 20 | 24 |
|---|---|---|---|---|
| A MAX | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN | 9,90 | 9,90 | 12,30 | 14,70 |

4040062/C 03/03

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

W (R–GDFP–F16) CERAMIC DUAL FLATPACK




NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP2–F16

# GENERIC PACKAGE VIEW

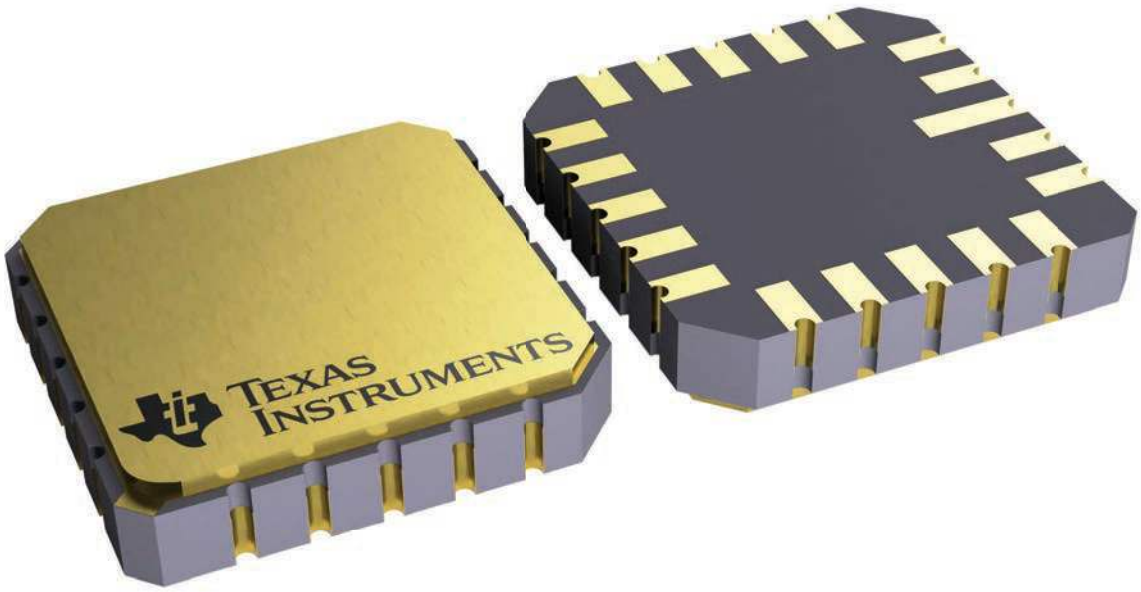
## FK 20

## LCCC - 2.03 mm max height

**8.89 x 8.89, 1.27 mm pitch**

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

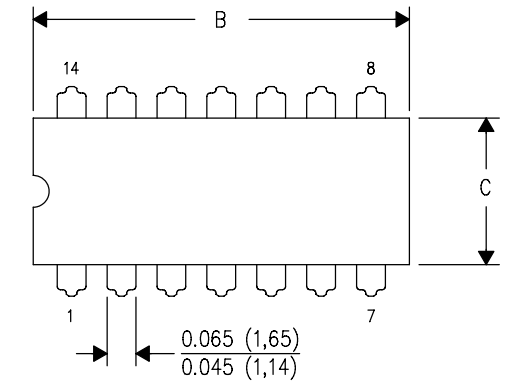



4229370\VA\

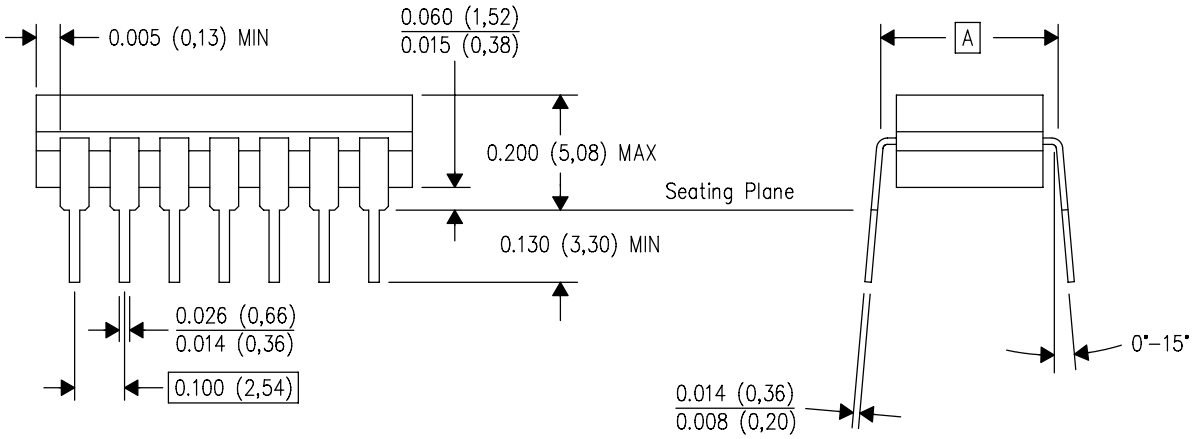
J (R–GDIP–T**)

14 LEADS SHOWN

# CERAMIC DUAL IN–LINE PACKAGE




| DIM \ PINS ** | 14 | 16 | 18 | 20 |
|---|---|---|---|---|
| A | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC |
| B MAX | 0.785 (19,94) | .840 (21,34) | 0.960 (24,38) | 1.060 (26,92) |
| B MIN | — | — | — | — |
| C MAX | 0.300 (7,62) | 0.300 (7,62) | 0.310 (7,87) | 0.300 (7,62) |
| C MIN | 0.245 (6,22) | 0.245 (6,22) | 0.220 (5,59) | 0.245 (6,22) |



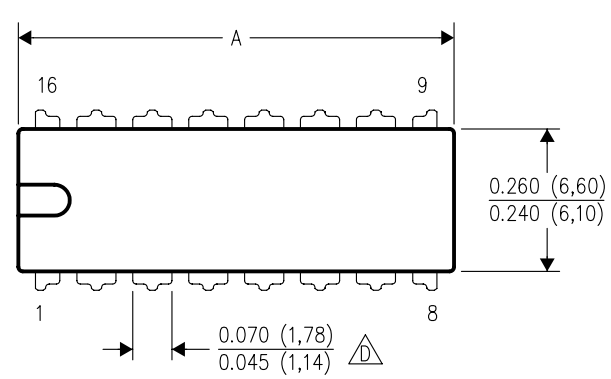

4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

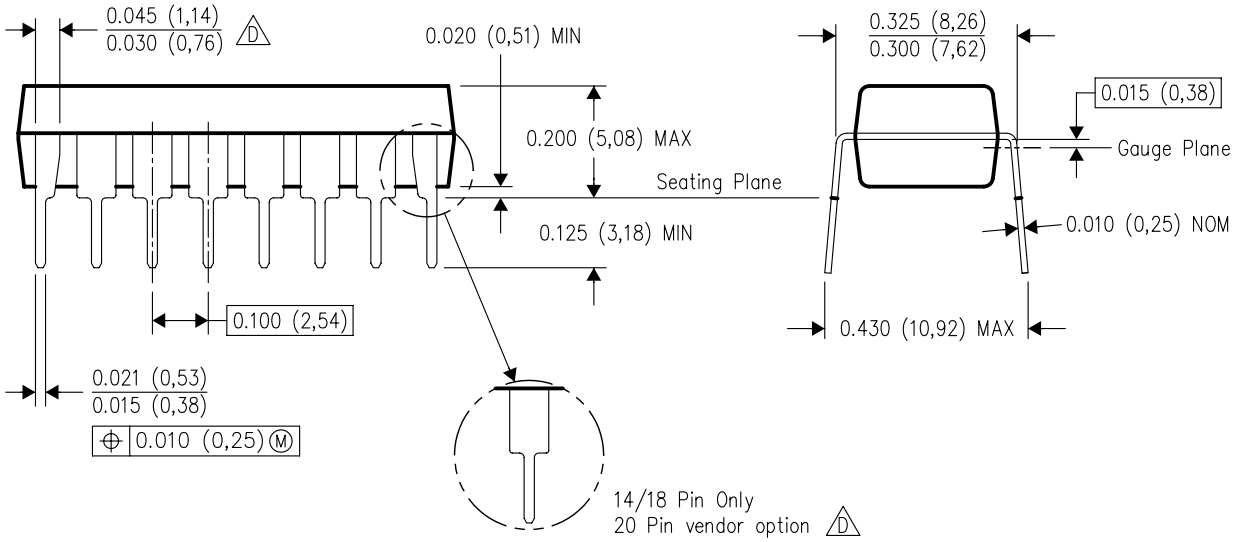
## N (R–PDIP–T**)

## PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN

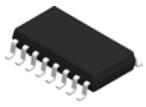



| DIM \ PINS ** | 14 | 16 | 18 | 20 |
|---|---|---|---|---|
| A MAX | 0.775 (19,69) | 0.775 (19,69) | 0.920 (23,37) | 1.060 (26,92) |
| A MIN | 0.745 (18,92) | 0.745 (18,92) | 0.850 (21,59) | 0.940 (23,88) |
| MS–001 VARIATION (C) | AA | BB | AC | AD |




4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

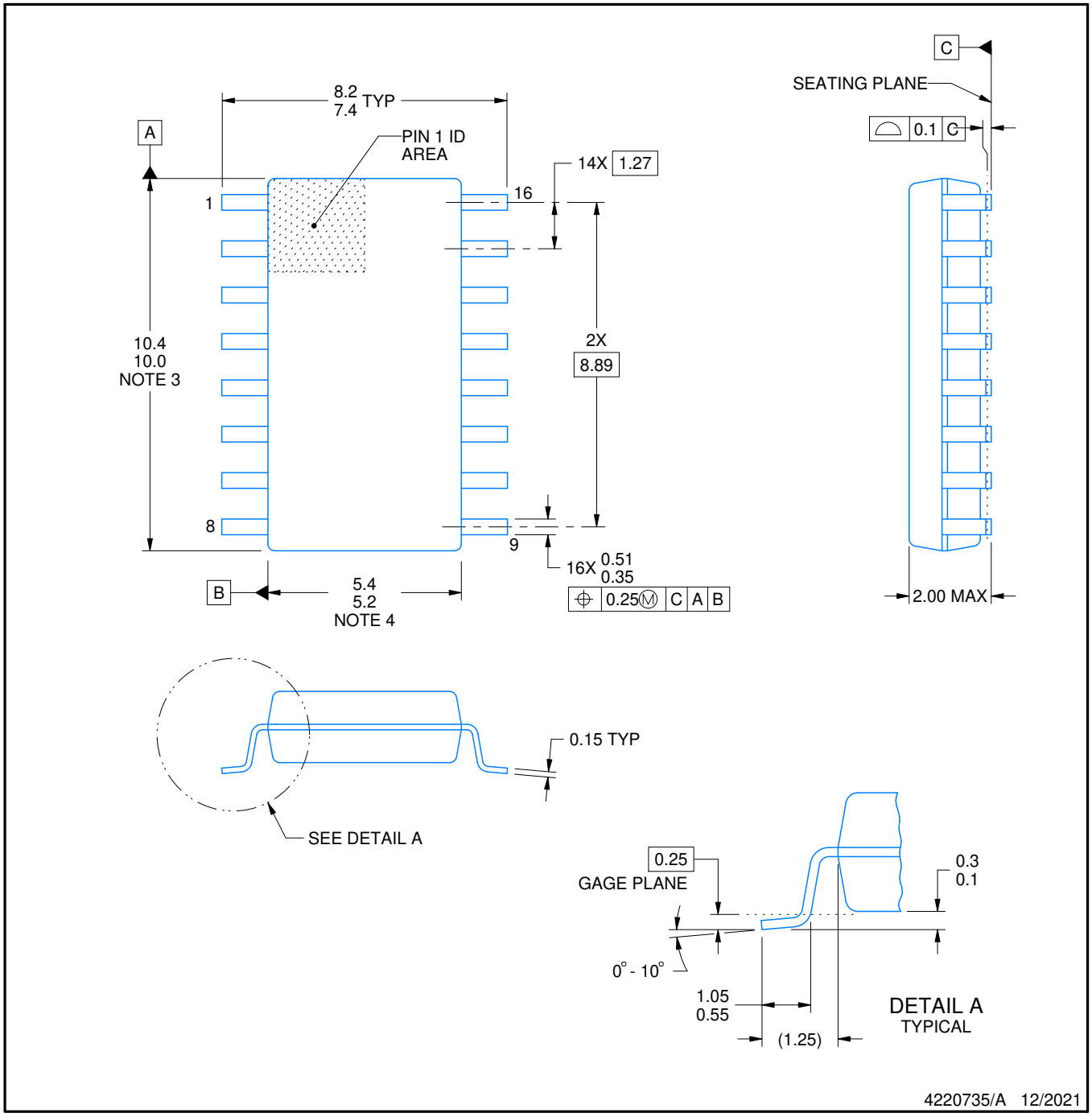


# PACKAGE OUTLINE

## NS0016A

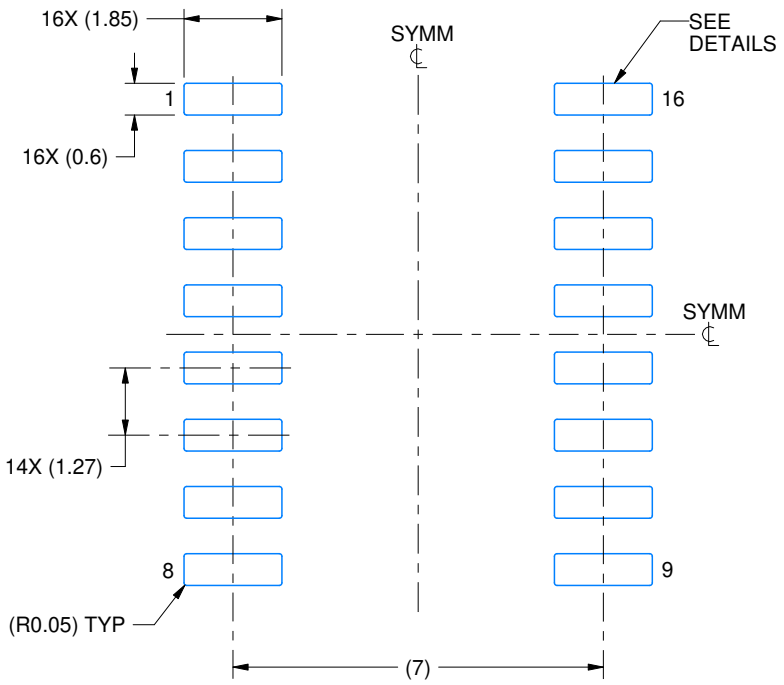
## SOP - 2.00 mm max height

SOP

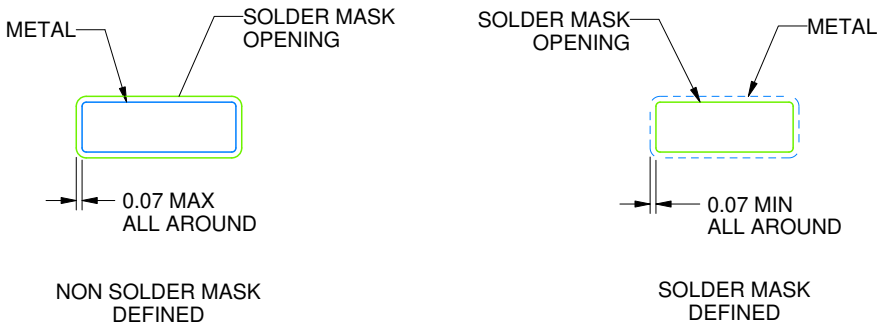



NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.




LAND PATTERN EXAMPLE
SCALE:7X

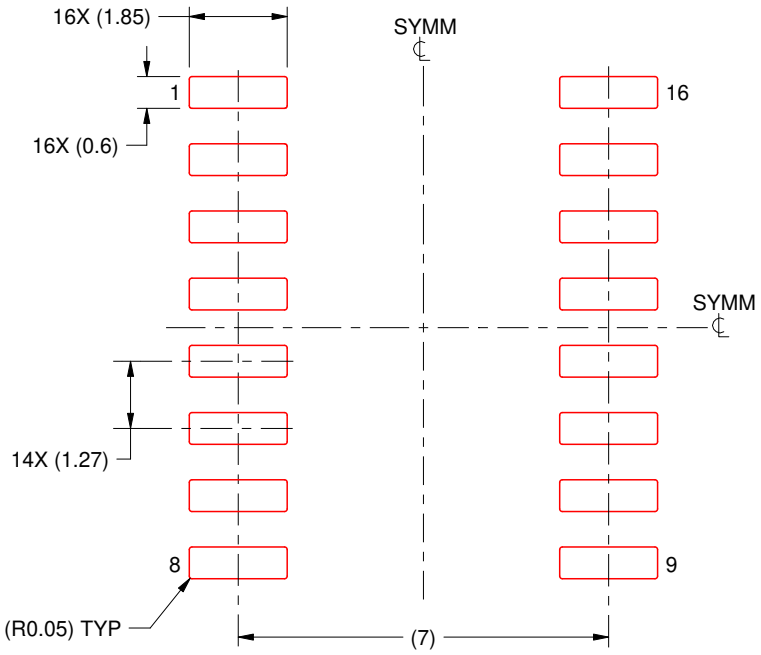



SOLDER MASK DETAILS

4220735/A 12/2021

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.




SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

4220735/A 12/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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